
Atmel AVR123: AT90PWM81/161 ADC Conversion Optimization Versus Temperature



Features

- Optimization of ADC conversion results versus temperature
- Applicable to the Atmel® AT90PWM81/161 when using the internal V_{REF} for the ADC

1 Introduction

The AT90PWM81/161 features a 10-bit successive approximation ADC. The ADC is connected to a 15-channel analog multiplexer, which provides:

- 11 single-ended inputs which are referenced to 0V (GND)
- Two differential voltage input combinations, which come with a programmable gain stage, providing amplification steps of 14dB (5x), 20 dB (10x), 26 dB (20x), or 32dB (40x) on the differential input voltage before the A/D conversion. On the amplified channels, 8-bit resolution can be expected

This application note explains how to re-adjust the ADC conversion results over the temperature.

8-bit Atmel Microcontrollers

Application Note

Rev. 8270B-AVR-01/12



2 Theory of operation – the ADC conversion

2.1 V_{REF} control

The reference voltage for the ADC (V_{REF}) indicates the conversion range for the ADC. It can be selected as either:

- AVCC,
- internal 2.56V reference,
- or the voltage present on the external AREF pin.

The internal reference V_{REF} of 2.56V is generated, after multiplication, from the Bandgap voltage.

2.2 V_{REF} calibration

This internal voltage reference is function of the temperature.

It is calibrated at factory @3V and ambient temperature within accuracy of $\pm 1\%$ of the 2.56V reference voltage. The result of this calibration is stored in the Signature Row. This Final Test “Amb.VREF” is loaded at address 0x1E (please also see the Atmel AT90PWM81/161 datasheet).

Still at factory, a reading of the V_{REF} level is achieved at 105°C. This value is also stored in the Signature Row. This Final Test “Hot VRef” is loaded at address 0x1F.

2.3 ADC conversion

For single ended conversions, the conversion result is:

$$\text{Read ADC} = V_{\text{IN}} \times 1023 / V_{\text{REF}}$$

where V_{IN} is the voltage on the selected input pin and V_{REF} the selected voltage reference.

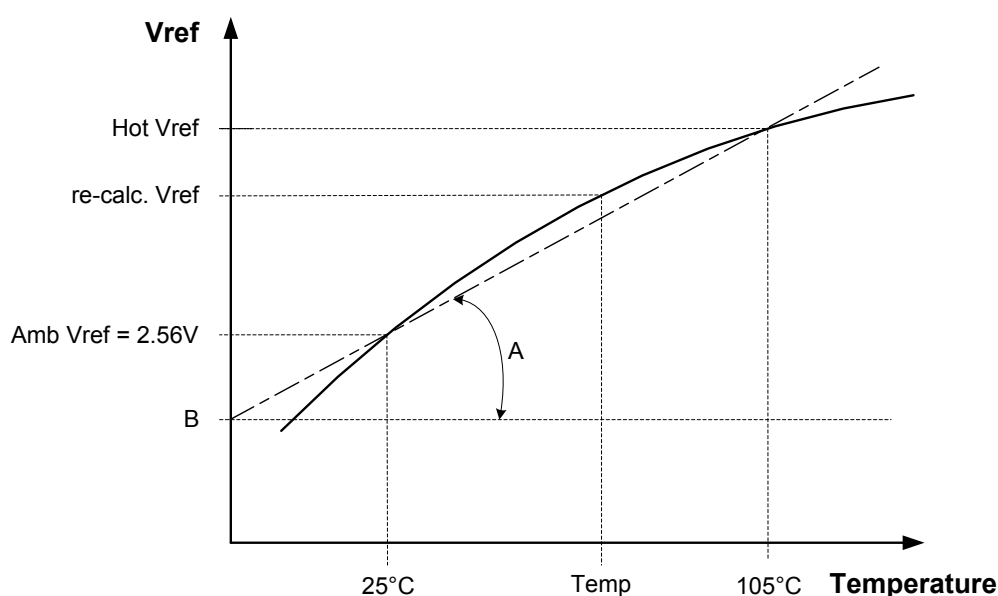
3 The compensation method

The Atmel AT90PWM81/161 microcontroller offers an embedded temperature sensor. This feature can be used for runtime compensation of temperature drift in the voltage reference.

3.1 V_{REF} versus temperature

In following example, we consider the default configuration of BGCRR Register which shifts the top of the V_{REF} curve to the highest possible temperature. In this configuration; the higher the temperature is, the higher the V_{REF} .

Figure 3-1. V_{REF} versus temperature.



Notes:

1. Amb V_{REF} is not necessarily strictly equal to 2.56V depending on the calibration ($\pm 1\%$ accuracy).
2. Amb V_{REF} is the calibrated value at Factory = 2.56V @25°C with a $\pm 1\%$ accuracy
Hot V_{REF} is the Read value at Factory @105°C.
3. Amb V_{REF} and Hot V_{REF} are stored in Signature Row during Test operation at Factory and can be read by Software:
4. Final Test Amb V_{REF} : is loaded in two bytes at Address 0x3D (High Byte) 0x3C (Low Byte).
5. Final Test Hot V_{REF} (only for Read): is loaded in two bytes at Address 0x3F/0x3E.

These constants are the hexadecimal value of the voltage in mV: for instance 0x0A00 represents the Hexadecimal value of 2560mV.

3.2 Temperature measurement

This implementation uses the measurement achieved with the embedded temperature sensor of the AT90PWM81/161.



If the temperature sensor has been selected, the temperature measurement formula is:

$$\text{Temp (}^{\circ}\text{C)} = ((([(\text{ADCH} \ll 8) | \text{ADCL}] - (273 + 25\text{-TSOFFSET})) \times \text{TSGAIN}) / 128) + 25$$

TSGAIN and TSOFFSET are stored in the Signature Row during Test operation at Factory:

Temperature Sensor Offset: TSOFFSET is loaded in High Byte of Address 0x05

Device Temperature Sensor Gain: TSGAIN is loaded in High Byte of Address 0x07 (typical value is 0x80)

3.3 V_{REF} recalculation

Between 25°C and 105°C, V_{REF} curve versus temperature range can be extrapolated as a straight line (see [Figure 3-1](#)).

To improve overall V_{REF} accuracy, the recalculated V_{REF} can be calculated as following:

$$\text{Re-calc. } V_{\text{REF}} = (A \times \text{Temp}) + B$$

The known points of the straight line are:

$$\text{Amb } V_{\text{REF}} = (A \times (25^{\circ}\text{C})) + B = \text{data stored in Signature Byte}$$

$$\text{Hot } V_{\text{REF}} = (A \times (105^{\circ}\text{C})) + B = \text{data stored in Signature Byte}$$

A and B variables can be extracted from these two equations.

3.4 ADC measurement compensation

The ADC measurement result can be compensated with following formula:

$$\text{Compensated ADC} = \text{Read ADC} \times \text{Re-calc. } V_{\text{REF}} / 2.56$$

4 Hardware configuration

4.1 AT90PWM81/161

Five parts have been tested. Their Fuse configuration is:

Extended = FD

High = D9

Low = CC

4.2 STK521

XTAL: 8MHz

Monitoring of V_{REF} : A_{REF} output / V_{SS}

UART software output: PB0 connected to RS232 interface

4.3 Hyperterminal

UART Btrrate = 19200 bit/s



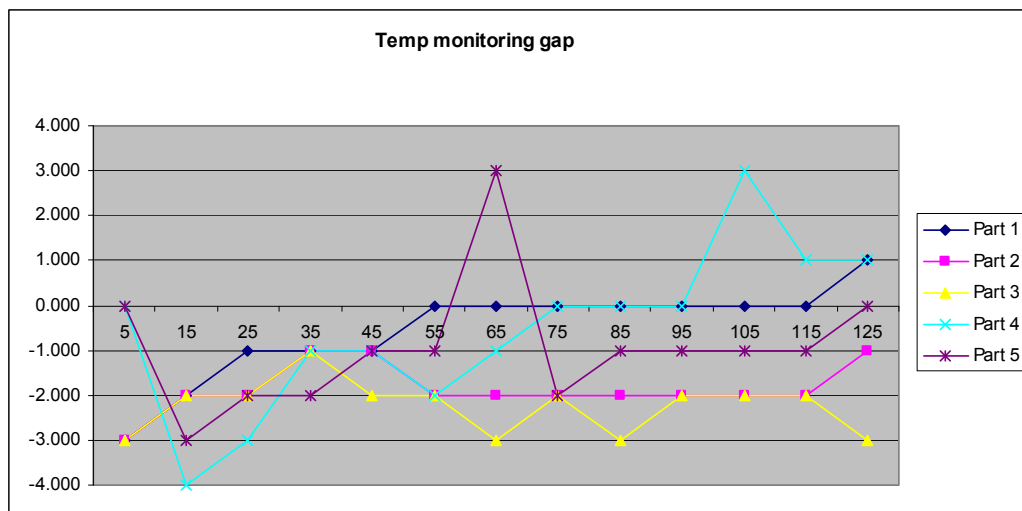
5 Software configuration

See Chapter 8: [Code example](#) (compiled with IAR).

6 Result of temperature measurement

The chart in [Figure 6-1](#) confirms that, over the five tested parts, the difference of temperature measurement is + 4°C.

Figure 6-1. Temperature monitoring gap.

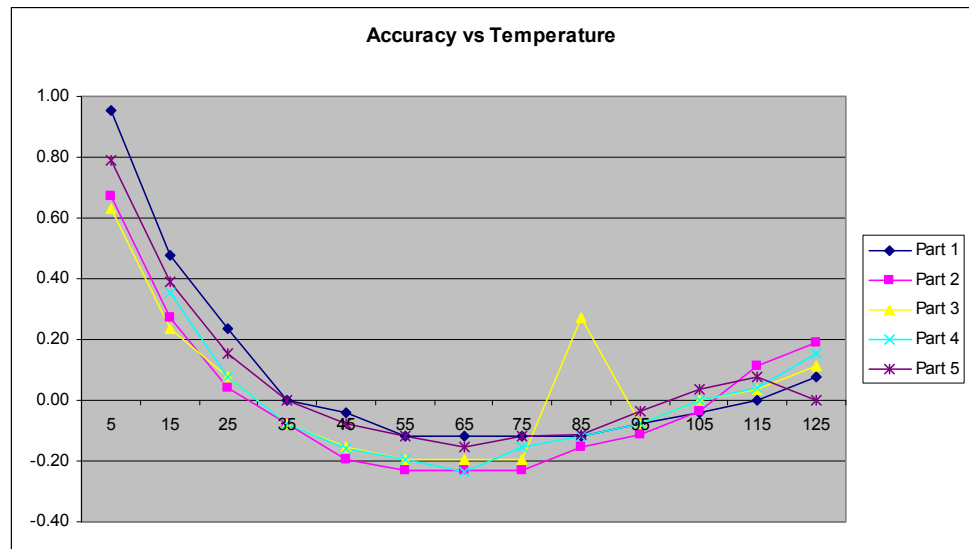


7 Results of V_{REF} recalculation

The chart in [Figure 7-1](#) provides the accuracy (%) of the recalculated V_{REF} versus the real V_{REF} over the temperature range:

$$= (V_{REF} \text{ Recalculated} - V_{REF} \text{ output monitoring}) / V_{REF} \text{ output monitoring}$$

Figure 7-1. Accuracy vs. temperature.



These typical results confirm that over a temperature range of [+5°C to +125°C]; the accuracy of the recalculation is better than 1%.

8 Code example

8.1 C Main function

```
//! //! Copyright (c) 2009 Atmel.
//! This program uses a loop to:
//! - monitor the temperature sensor
//! - calculate the  $V_{REF}$  which should be equal to the real internal  $V_{REF}$ 
/

//__INCLUDES__
#include "config.h"
#include "iopwm81.h"
#include "my_print.h"

//__DECLARATIONS__

#define HIGHBYTE(v) (((unsigned char) (((unsigned int) (v)) >> 8)));
#define LOWBYTE(v) ((unsigned char) (v));

int main(void)
{
    unsigned char gain, offset, temp, vref_amb_low, vref_hot_low, vref_amb_high,
    vref_hot_high, result;
    unsigned int vref_recalc, vref_amb, vref_hot, n;
    char g, i;
    float a, b;

    PORTB= 0x00;
    DDRB=0xC7;
    ADCSRA |= 0x80; /* ADEN=1 */
    ADMUX |= 0x80; /* Vref=2.56V */
    ADMUX &= ~0x2F;
    ADMUX |= 0x0C; /* MUX to Temp sensor */
    ADCSRB = 0x80; /* ADC High speed + free running */
    ADCSRA |= 0x04; /* prescaler /16 */
    ADCSRA |= (1<<ADSC); /* first conversion */
```



```
while (SPMEN==1);

asm("LDI R17,$00");/* Beginning of LPM sequence to read the Temp. sensor
OFFSET in Signature Row */
asm("LDI R16,$05");
asm("MOV R31,R17");/* */
asm("MOV R30,R16");/* ;move address to z pointer (R31=ZH R30=ZL)*/
SPMCSR=0x21;
asm("LPM");/* ;Store program memory*/
asm("MOV R16, R0");/* ;Store return value (1byte->R16 register)*/
asm("OUT 0x1B, R16");/* ;Store return value (1byte->R16 register)*/
while (SPMEN==1);
offset=GPIOR2; /* return of Temp. sensor OFFSET in Signature Row */

asm("LDI R17,$00") ;/*Beginning of LPM sequence to read the Temp. sensor GAIN
in Signature Row */
asm("LDI R16,$07");
asm("MOV R31,R17");/* */
asm("MOV R30,R16");/* ;move adress to z pointer (R31=ZH R30=ZL)*/
SPMCSR=0x21;
asm("LPM");/* ;Store program memory*/
asm("MOV R16, R0");/* ;Store return value (1byte->R16 register)*/
asm("OUT 0x1A, R16");/* ;Store return value (1byte->R16 register)*/
while (SPMEN==1);
gain=GPIOR1; /* return of Temp. sensor GAIN in Signature Row */

asm("LDI R17,$00");/*Beginning of LPM sequence to read the Vref. Amb.(low Byte)
in Signature Row */
asm("LDI R16,$3C");
asm("MOV R31,R17");/* */
asm("MOV R30,R16");/* ;move adress to z pointer (R31=ZH R30=ZL)*/
SPMCSR=0x21;
asm("LPM");/* ;Store program memory*/
asm("MOV R16, R0");/* ;Store return value (1byte->R16 register)*/
asm("OUT 0x1A, R16");/* ;Store return value (1byte->R16 register)*/
```

```
while (SPMEN==1);
vref_amb_low=GPIOR1; /* return of Vref. Amb. Low Byte in Signature Row */

asm("LDI R17,$00") /*Beginning of LPM sequence to read the Vref. Amb.(High
Byte) in Signature Row */
asm("LDI R16,$3D");
asm("MOV R31,R17");/* */
asm("MOV R30,R16");/* ;move adress to z pointer (R31=ZH R30=ZL)*/
SPMCSR=0x21;
asm("LPM");/* ;Store program memory*/
asm("MOV R16, R0");/* ;Store return value (1byte->R16 register)*/
asm("OUT 0x1A, R16");/* ;Store return value (1byte->R16 register)*/
while (SPMEN==1);
vref_amb_high=GPIOR1; /* return of Vref. Amb. High Byte in Signature Row */

asm("LDI R17,$00");/*Beginning of LPM sequence to read the Vref. Hot(low Byte) in
Signature Row */
asm("LDI R16,$3E");
asm("MOV R31,R17");/* */
asm("MOV R30,R16");/* ;move adress to z pointer (R31=ZH R30=ZL)*/
SPMCSR=0x21;
asm("LPM");/* ;Store program memory*/
asm("MOV R16, R0");/* ;Store return value (1byte->R16 register)*/
asm("OUT 0x1A, R16");/* ;Store return value (1byte->R16 register)*/
while (SPMEN==1);
vref_hot_low=GPIOR1; /* return of Vref. Hot Low Byte in Signature Row */

asm("LDI R17,$00");/*Beginning of LPM sequence to read the Vref. Hot(High Byte)
in Signature Row */
asm("LDI R16,$3F");
asm("MOV R31,R17");/* */
asm("MOV R30,R16");/* ;move adress to z pointer (R31=ZH R30=ZL)*/
SPMCSR=0x21;
asm("LPM");/* ;Store program memory*/
asm("MOV R16, R0");/* ;Store return value (1byte->R16 register)*/
asm("OUT 0x1A, R16");/* ;Store return value (1byte->R16 register)*/
while (SPMEN==1);
```





```
vref_hot_high=GPIOR1; /* return of Vref. Hot High Byte in Signature Row */

vref_hot= (vref_hot_high * 256) + vref_hot_low;
vref_amb = (vref_amb_high * 256) + vref_amb_low;
a=(vref_hot - vref_amb)*100;
a = a / 0x50;
b= vref_amb - ((a * 0x19)/100);

while(1)
{
    while (ADIF == 0);
    ADCSRA |=0x10; /* reset ADIF */
    temp =ADCL;
    result =(ADCH<<8);
    result = result | temp;
    result = result - (273+25-offset);
    temp = gain / 128;
    result = result * temp;
    temp = result +25;

    putchar(0x54); putchar(0x3D);print_hex(temp);/* T=... temperature measurement in
hex format*/

    for(i=1;i<100;i++); putchar(0x0D); for(i=1;i<100;i++); putchar(0x0A);

    vref_recalc = (((a * temp)/100) + b); /* Vref. recalculated versus the temperature
measurement */

    putchar(0x41);putchar(0x3D);
    print_hex(vref_amb_high);
    print_hex(vref_amb_low);
    for(i=1;i<100;i++); putchar(0x0D); for(i=1;i<100;i++); putchar(0x0A); /* A=... Vref
Amb. in hex format*/

    putchar(0x48);putchar(0x3D);
    print_hex(vref_hot_high);
    print_hex(vref_hot_low);
```

```
    for(i=1;i<100;i++); putchar(0x0D); for(i=1;i<100;i++); putchar(0x0A); /* H=... Vref
Hot. in hex format*/

    putchar(0x52);putchar(0x3D); /* R=... Vref recalculated in hex format*/
    temp=HIGHBYTE(vref_recalc);
    print_hex (temp);
    temp=LOWBYTE(vref_recalc);
    print_hex (temp);
    for(i=1;i<100;i++); putchar(0x0D); for(i=1;i<100;i++); putchar(0x0A); /* R=... Vref
Recalculated in hex format*/
    for(n=1;n<10000;n++)
    {
        for(i=1;i<100;i++);/* Delay to improve display in Hyperterminal */
    }
    ADMUX |=0x0C;
    ADCSRA |= (1<<ADSC); /* Starts a new conversion on Temp. sensor */
}
}
```

8.2 C Software UART function

```
#include "my_print.h"
void print_hex(unsigned char n)
{
    unsigned char i;
    i=n>>4;
    if(i>9) putchar(i-0x0A+'A');
    else putchar(i+'0');
    i=n&0x0F;
    if(i>9) putchar(i-0x0A+'A');
    else putchar(i+'0');
}

void print_int(unsigned int n)
{
    print_hex(n>>8);
    print_hex(n);
}
```



8.3 Assembler Soft_uart.s90

```
// include the register definitions for the used AT90PWM81/161
mcu
#include "iopwm81.h"

PUBLIC putchar
PUBLIC soft_uart_init

;***** Pin definitions

TxD EQU      0                      ;Transmit pin is PDx

;***** Global register variables

#define bitcnt r16                    ;bit counter
#define      temp  r17                ;temporary storage register

#define Txbyte r18                    ;Data to be transmitted

RSEG CODE:CODE:NOROOT(1)

;*****
;*
;* "putchar"
;*
;* This subroutine transmits the byte stored in the "Txbyte" register
;* The number of stop bits used is set with the sb constant
;*
;* Number of words          :14 including return
;* Number of cycles          :Depends on bit rate
;* Low registers used        :None
;* High registers used       :2 (bitcnt,Txbyte)
;* Pointers used             :None
;*
;*****
sb EQU 1                      ;Number of stop bits (1, 2, ...)

putchar:
cli
ldi bitcnt, (9+sb)            ;1+8+sb (sb is # of stop bits)
mov r18, r16
ldi r16, (9+sb) ;1+8+sb (sb is # of stop bits)
com Txbyte                    ;Inverte everything
sec                           ;Start bit

putchar0: brcc putchar1        ;If carry set
cbi PORTB,TxD                 ; send a '0'
rjmp putchar2                 ;else

putchar1: sbi PORTB,TxD        ; send a '1'
nop

putchar2: rcall UART_delay     ;One bit delay
```

```

        rcall UART_delay

        lsr    Txbyte                ;Get next bit
        dec    bitcnt                ;If not all bit sent
        brne   putchar0             ; send next
                                           ;else

        sei
        ret                        ; return

;*****
;*
;* "UART_delay"
;*
;* This delay subroutine generates the required delay between the bits
when
;* transmitting and receiving bytes. The total execution time is set
by the
;* constant "b":
;*
;*      3•b + 7 cycles (including rcall and ret)
;*
;* Number of words      :4 including return
;* Low registers used    :None
;* High registers used   :1 (temp)
;* Pointers used         :None
;*
;*****

b EQU 63

UART_delay:
    ;ldi    temp,b
    nop
    nop
    ldi     r17,b
UART_delay1:    dec    temp
                brne   UART_delay1

                ret

;***** Program Execution Starts Here

;***** Test program

soft_uart_init:
    sbi     PORTB,TxD    ;Init port pins
    sbi     DDRB,TxD
    ret

forever:
    ldi     r18,0x55      ;'U'
    rcall   putchar
    rjmp    forever

END

```





9 Application note revision history

Please note that the page numbers are referring to this document. The revision reference in this section is to the document revision.

9.1 Rev. 8270B – 01/12

1. AT90PWM161 is added.

9.2 Rev. 8270A – 09/10

1. Initial version.

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